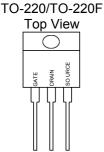
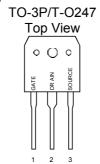


U03GENERAL DESCRIPTION

This high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition, this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes. The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power supplies, converters and PWM motor controls, these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

PIN CONFIGURATION

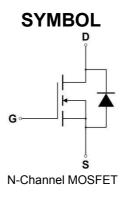




ABSOLUTE MAXIMUM RATINGS

FEATURES

- Robust High Voltage Termination
- Avalanche Energy Specified
- Source-to-Drain Diode Recovery Time Comparable to a Discrete Fast Recovery Diode
- Diode is Characterized for Use in Bridge Circuits
- IDSS and VDS(on) Specified at Elevated Temperature
- Isolated Mounting Hole Reduces Mounting Hardware



Rating		Value	Unit	
Drain to Current – Continuous	I _{D (1)}	18.6	А	
- Pulsed	I _{DM}	55.8		
Gate-to-Source Voltage — Continue	V_{GS}	±20	V	
Total Power Dissipation –TO-220		184	14/	
-TO-220FP		36		
-TO-3P		198	W	
-TO2-47		184		
Derate above 25℃ –TO-220	PD	1.47		
-TO-220FP		0.29		
-TO-3P		1.59	W/°C	
-TO-24		1.47		
Junction and Storage Temperature Range	T _J , T _{STG}	-55 to 150	°C	
Single Pulse Drain-to-Source Avalanche Energy $- T_J$ = 25 °C (V _{DD} = 100V, V _{GS} = 10V, I _L = 6.8A, L = 10mH, R _G = 25Ω)	Eas	271.2	mJ	
Thermal Resistance – Junction to Case -TO-220	θις	0.68		
 Junction to Case -TO-220FP 		3.5		
 Junction to Case -TO-3P 		0.63	°C 11/	
- Junction to Case -TO-247		0.68	°C/W	
 Junction to Ambient -TO-220, TO-220FP Junction to Ambient -TO-3P, TO-247 	θ _{JA}	62.5		
		40		
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	ΤL	260	°C	
1) Drain current limited by maximum junction temperature (TO3P)				



ORDERING INFORMATION

Part Number	TOP MARK	Part Number	Packing Mthod	Note
GWM19S65N220	GWM19S65	TO-220	Tube	
GWM19S65N220FP	GWM19S65	TO-220FP	Tube	
GWM19S65N3P	GWM19S65	TO-3P	Tube	
GWM19S65N247	GWM19S65	TO-247	Tube	

ELECTRICAL CHARACTERISTICS

Unless otherwise specified, $T_{\rm J}$ = 25 $^\circ\!{\rm C}$.

			GWM19S65			
Cha	Symbol	Min	Тур	Max	Units	
Drain-Source Breakdown Voltage (V _{GS} = 0 V, I _D = 250 μ A)	V _{(BR)DSS}	650			V	
Drain-Source Leakage Current (V _{DS} =650 V, V _{GS} = 0 V)	I _{DSS}			1	uA	
Gate-Source Leakage Current-Fo (V _{gsf} = 20 V, V _{DS} = 0 V)	I _{GSSF}			100	nA	
Gate-Source Leakage Current-Re (V _{gsr} = - 20 V, V _{DS} = 0 V)	I _{GSSR}			100	nA	
Gate Threshold Voltage (V _{DS} = V _{GS} , I _D = 250 μ A)	V _{GS(th)}	2	3.5	4	V	
Static Drain-Source On-Resistance (V _{GS} = 10 V, I _D = 6.2A) *		R _{DS(on)}			230	mΩ
Gate resistance (f=1MHz, open drain)		R _G		2.7		Ω
Input Capacitance	(V _{DS} = 100 V, V _{GS} = 0 V, f = 1.0 MHz)	Ciss		1500		pF
Output Capacitance		C _{oss}		59		pF
Reverse Transfer Capacitance		Crss		32		pF
Turn-On Delay Time		t _{d(on)}		18.8		ns
Rise Time	(V _{DD} = 325 V, I _D = 19 A,	tr		45.6		ns
Turn-Off Delay Time	R _G = 25Ω) *	t _{d(off)}		37.4		ns
Fall Time		t _f		58.6		ns
Total Gate Charge	(V _{DS} = 520 V, I _D = 19 A,	Qg		41.7		nC
Gate-Source Charge	$V_{DS} = 520 \text{ V}, \text{ I}_D = 19 \text{ A},$ $V_{GS} = 10 \text{ V})^*$	Q _{gs}		9.3		nC
Gate-Drain Charge		Q _{gd}		17.9		nC
SOURCE-DRAIN DIODE CHARA	CTERISTICS					
Forward On-Voltage(1)	(110 A	Vsd			1.5	V
Forward Turn-On Time	- (I _S =19 A, - d _{IS} /d _t = 100A/μs)	t _{on}		**		ns
Reverse Recovery Time		t _{rr}		388.93		ns

* Pulse Test: Pulse Width ${\leq}300\mu\text{s},$ Duty Cycle ${\leq}2\%$

** Negligible, Dominated by circuit inductance



TYPICAL ELECTRICAL CHARACTERISTICS

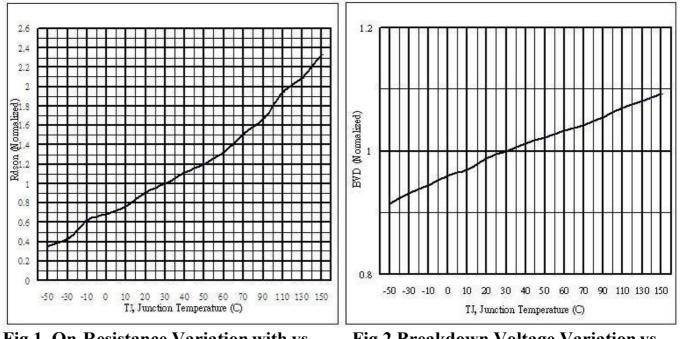


Fig 1. On-Resistance Variation with vs. Temperature



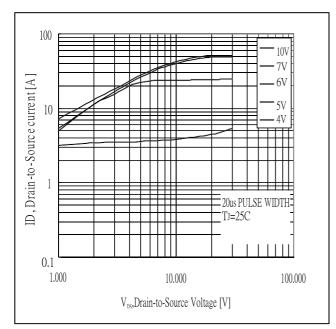


Fig 3. Typical Output Characteristics

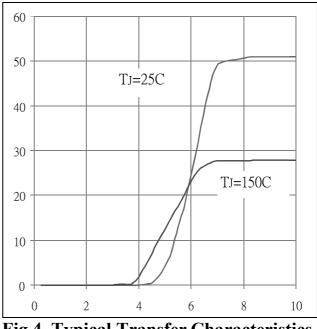


Fig 4. Typical Transfer Characteristics



GWM19S65 Power Field Effect Transistor

